

Description

The DMP3036SFV uses advanced trench technology

to provide excellent R_{DS(ON)}, low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

General Features

V_{DS} =-30V I_D =-25A

 $R_{DS(ON)} < 20m\Omega @ V_{GS}=-10V$

Application

Battery protection

Load switch

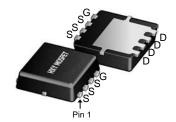
Uninterruptible power supply

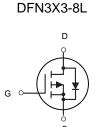
Package Marking and Ordering Information

| Product ID | Pack | Brand | Qty(PCS) |
|------------|-------|------------|----------|
| DMP3036SFV | SOP-8 | HXY MOSFET | 3000 |

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

| Symbol | Parameter | Rating | Units |
|--------------------------------------|--|------------|-------|
| VDS | Drain-Source Voltage | -30 | V |
| VGS | Gate-Source Voltage | ±20 | V |
| I _D @T _C =25°C | Continuous Drain Current, V _{GS} @ 10V ¹ | -25 | A |
| I _D @Tc=100°C | Continuous Drain Current, V _{GS} @ 10V ¹ | -20 | A |
| IDM | Pulsed Drain Current ² | -65 | A |
| EAS | Single Pulse Avalanche Energy ³ | 72.2 | mJ |
| P₀@Tc=25°C | Total Power Dissipation ⁴ | 29 | W |
| TSTG | Storage Temperature Range | -55 to 150 | °C |
| TJ | Operating Junction Temperature Range | -55 to 150 | °C |
| R₀JC | Thermal Resistance Junction-Case ¹ | 2.8 | °C/W |





P-Channel MOSFET

Electrical Characteristics (T_J=25 °C, unless otherwise noted)

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit | |
|---|--|---|------|--------|------|-------|--|
| BV _{DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V , I _D =-250uA | -30 | | | V | |
| $\bigtriangleup BV_{\text{DSS}} \bigtriangleup T_J$ | BV _{DSS} Temperature Coefficient | Reference to 25° C $, I_{D}$ =-1mA | | -0.022 | | V/°C | |
| R _{DS(ON)} | Statis Drain Source On Desistance ² | V _{GS} =-10V , I _D =-15A | | 16 | 20 | mΩ | |
| | Static Drain-Source On-Resistance ² | V _{GS} =-4.5V , I _D =-10A | | 22 | 32 | | |
| V _{GS(th)} | Gate Threshold Voltage | | -1.0 | | -2.5 | V | |
| $\bigtriangleup V_{\text{GS(th)}}$ | V _{GS(th)} Temperature Coefficient | ──V _{GS} =V _{DS} , I _D =-250uA | | 4.6 | | mV/°C | |
| I | I _{DSS} Drain-Source Leakage Current | V _{DS} =-24V , V _{GS} =0V , T _J =25°C | | | -1 | uA | |
| IDSS | | V _{DS} =-24V , V _{GS} =0V , T _J =55°C | | | -5 | | |
| lgss | Gate-Source Leakage Current | $V_{GS} = \pm 25V$, $V_{DS} = 0V$ | | | ±100 | nA | |
| Rg | Gate Resistance | V _{DS} =0V , V _{GS} =0V , f=1MHz | | 13 | | Ω | |
| Qg | Total Gate Charge (-4.5V) | | | 52 | | | |
| Q _{gs} | Gate-Source Charge | V _{DS} =-15V , V _{GS} =-4.5V , I _D =-15A | | 9.8 | | nC | |
| Q _{gd} | Gate-Drain Charge | | | 8.3 | | | |
| T _{d(on)} | Turn-On Delay Time | | | 13 | | | |
| Tr | Rise Time | V_{DD} =-15V , V_{GS} =-10V , R_{G} =3.3 Ω , | | 15 | | | |
| T _{d(off)} | Turn-Off Delay Time | I _D =-15A | | 198 | | ns | |
| T _f | Fall Time | | | 98 | | | |
| Ciss | Input Capacitance | | | 1150 | | | |
| Coss | Output Capacitance | V _{DS} =-15V , V _{GS} =0V , f=1MHz | | 150 | | pF | |
| Crss | Reverse Transfer Capacitance | | | 134 | | | |
| ls | Continuous Source Current ^{1,5} | −−−V _G =V _D =0V , Force Current | | | -32 | А | |
| Ism | Pulsed Source Current ^{2,5} | | | | -65 | А | |
| V_{SD} | Diode Forward Voltage ² | V _{GS} =0V , I _S =-1A , T _J =25°C | | | -1.2 | V | |

Note :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper. 2. The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%

3. The EAS data shows Max. rating . The test condition is V_{DD} =-25V, V_{GS} =-10V, L=0.1mH, I_{AS} =-38A

4. The power dissipation is limited by 150°C junction temperature

5. The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.



Typical Characteristics

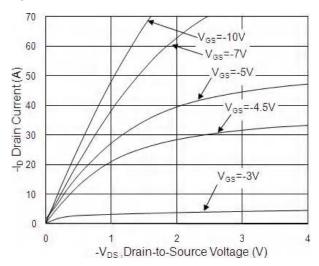


Fig.1 Typical Output Characteristics

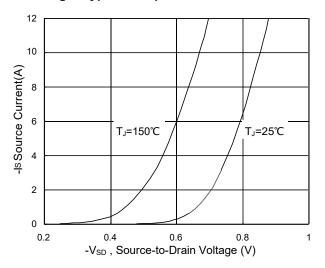
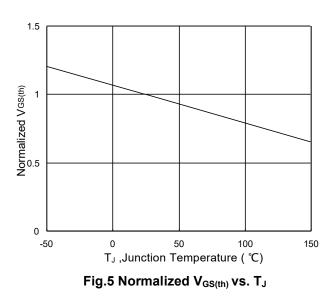


Fig.3 Forward Characteristics of Reverse



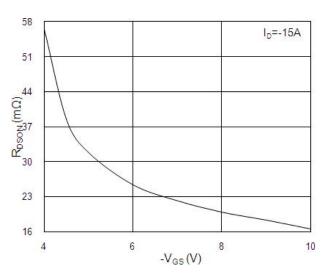


Fig.2 On-Resistance v.s Gate-Source

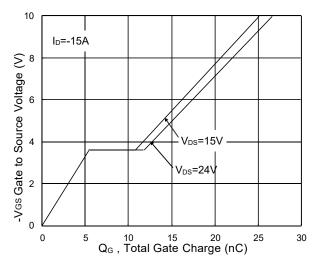


Fig.4 Gate-Charge Characteristics

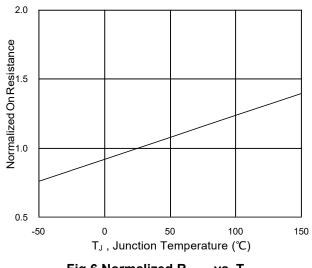
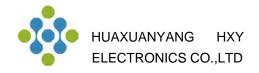


Fig.6 Normalized R_{DSON} vs. T_J



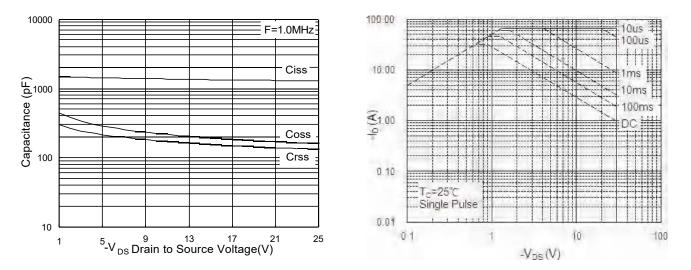
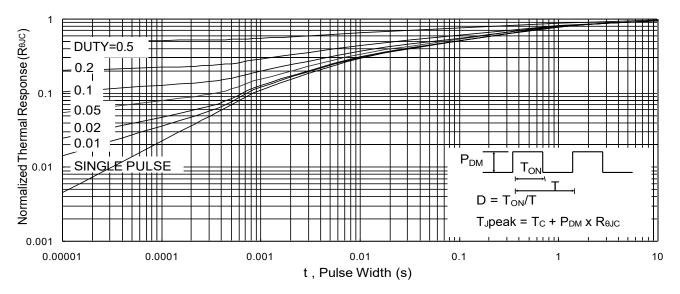


Fig.7 Capacitance

Fig.8 Safe Operating Area





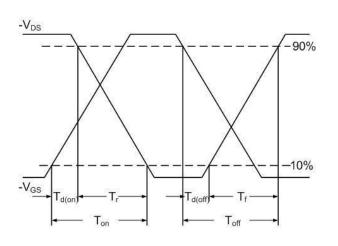
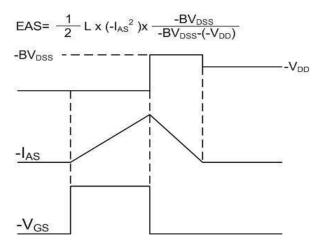


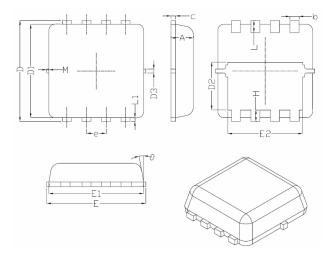
Fig.10 Switching Time Waveform







DFN3X3-8L Package Information



| Symbol | Dimensions In Millimeters | | |
|--------|---------------------------|-----------------|-----------------|
| | Min. | Nom. | Max. |
| A | 0.70 | 0.75 | 0.80 |
| b | 0.25 | 0.30 | 0.35 |
| С | 0.10 | 0.15 | 0.25 |
| D | 3.25 | 3.35 | 3.45 |
| D1 | 3.00 | 3.10 | 3.20 |
| D2 | 1.48 | 1.58 | 1.68 |
| D3 | - | 0.13 | - |
| E | 3.20 | 3.30 | 3.40 |
| E1 | 3.00 | 3.15 | 3.20 |
| E2 | 2.39 | 2.49 | 2.59 |
| e | 0.65BSC | | |
| Н | 0.30 | 0.39 | 0.50 |
| L | 0.30 | 0.40 | 0.50 |
| L1 | - | 0.13 | - |
| М | * | * | 0.15 |
| θ | | 10 [°] | 12 [°] |



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